





MMSZ4689

General Description

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

Features

- · Compact surface mount with same footprint as mini-melf
- 500mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16kV) per Human Body Model

Ordering

• 7 inch reel (178mm); 8mm Tape; 3,000 units per reel.

Absolute Maximum Ratings (note 1) T_A=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
T _{STG}	Storage Temperature	-55 ~ 150	°C	
TJ	Maximum Junction Temperature	-55 ~ 150	°C	
PD			mW mW/°C	
R _{QJA}	Thermal Resistance Junction to Ambient	340	°C/W	
R _{qJA} R _{qJL}	Thermal Resistance Junction to Lead	150	°C/W	
ΔVZ	Maximum Voltage Change (note 2)	970	mV	
Lead Solder Temperature (Max 10 second duration)		260	°C	
Nominal Zener	Voltage (V _Z) at 50μA	5.1	V	

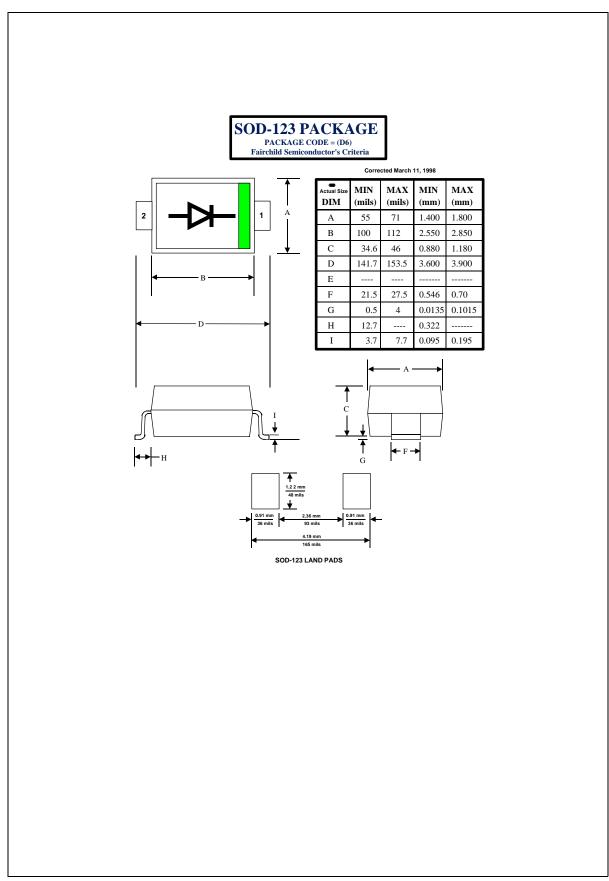
Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Note 2: Voltage change is equal to the difference between V_z at 100μ A and V_z at 10μ A.

Top Mark: CU 1: Cathode 2: Anode



Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Characteristics	Test Conditions	Min.	Max.	Units
VZ	Zener Voltage	$I_{ZT} = 50\mu A_{D.C}$	4.85	5.36	V
I _R	Reverse Leakage	$V_R = 3.0V$		10	μA
V _F	Forward Voltage	I _F = 10mA		900	mV
ΔVZ	Delta Zener Voltage (Note 2)	$I_{ZT} = 100 \mu A$ to $10 \mu A$		970	mV



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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
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Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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